

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Hajime IKUTA	01/20/2010
Tatsuo SUMINO	01/20/2010
RECEIVING PARTY DATA	
Name:	Hitachi Plant Technologies, Ltd.
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PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	12696082
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PATENT
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ASSIGNMENT

For good and valuable consideration, the sufficiency and receipt of which is hereby acknowledged, as a below named inventor, I hereby sell and assign to Hitachi Plant Technologies, Ltd.

Of 5-2, Higashi-Ikebukuro 4-chome, Toshima-ku, Tokyo 170-8466, Japan
its successors and assigns or other legal representatives all my rights, title and interest, in and for the United States of America, in and to

**NITRITE TYPE NITRIFICATION-REACTIVE SLUDGE, PRODUCTION METHOD THEREFOR,
PRODUCTION APPARATUS THEREFOR, AND WASTE WATER TREATMENT METHOD AND
WASTE WATER TREATMENT APPARATUS**
invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefor, executed by me even date herewith, and all United States Letters Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said Hitachi Plant Technologies, Ltd. its successors, assigns or other legal representatives, to the full end of the term for which said Letters Patent may be granted, as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made:

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said
Hitachi Plant Technologies, Ltd.

	(Full Name)	(Signature)
1) Date <u>January 20, 2010</u> Inventor <u>Hajime IKUTA</u>	<u>Hajime Ikuta</u>	<u>Hajime Ikuta</u>
Residence <u>Toshima-ku, Tokyo, Japan</u> Citizenship <u>Japanese</u>		
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2) Date <u>January 20, 2010</u> Inventor <u>Tatsuo SUMINO</u>	<u>Tatsuo Sumino</u>	<u>Tatsuo Sumino</u>
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3) Date _____ Inventor _____		
Residence _____ Citizenship _____		
Post Office Address _____		

Witness(es) Kazuo Matsu

All) _____ 8) _____

1) _____ 5) _____ 9) _____

2) _____ 6) _____

3) _____ 7) _____